

1.5A, 1000V Fast Avalanche Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- · Fast switching for high efficiency
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

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 The superior avalanche capability of BYG21M is specially suited for free-wheeling, clamping, snubber, demagnetization in power supplies and other power switching applications.

MECHANICAL DATA

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- · Polarity: Indicated by cathode band
- Weight: 0.064g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
I _F	1.5	Α			
V_{RRM}	1000	V			
I _{FSM}	50	Α			
T_{JMAX}	150	°C			
Package	DO-214AC (SMA)				
Configuration Single die					









DO-214AC (SMA)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)						
PARAMETER	SYMBOL	BYG21M	UNIT			
Marking code on the device		BYG21M				
Repetitive peak reverse voltage	V_{RRM}	1000	V			
Reverse voltage, total rms value	$V_{R(RMS)}$	700	V			
Forward current	I _F	1.5	Α			
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	50	Α			
Pulse energy in avalanche mode, non-repetitive (Inductive load switch off), $I_{(BR)R} = 1.23A$	E _{RSM}	30	mJ			
Junction temperature	T_J	- 55 to +150	°C			
Storage temperature	T _{STG}	- 55 to +150	°C			



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THERMAL PERFORMANCE						
PARAMETER	SYMBOL	TYP	UNIT			
Junction-to-lead thermal resistance	$R_{\Theta JL}$	20	°C/W			
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	70	°C/W			

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT	
Forward voltage ⁽¹⁾	I _F = 1.0A, T _J = 25°C	V	-	1.5	V	
Forward voltage	I _F = 1.5A, T _J = 25°C	V_{F}	-	1.6	V	
	T _J = 25°C		-	1	μΑ	
Reverse current @ rated V _R ⁽²⁾	T _J = 100°C	I _R	-	10	μΑ	
	T _J = 125°C		-	50	μΑ	
Junction capacitance	1MHz, V _R = 4.0V	CJ	13	-	pF	
Reverse recovery time	$I_F = 0.5A, I_R = 1.0A,$ $I_{rr} = 0.25A$	t _{rr}	-	120	ns	

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE	PACKAGE	PACKING			
BYG21M	DO-214AC (SMA)	7,500 / Tape & Reel			



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

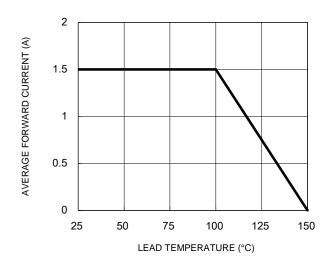


Fig.3 Typical Reverse Characteristics

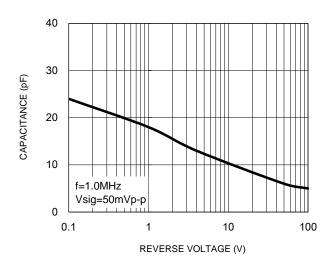
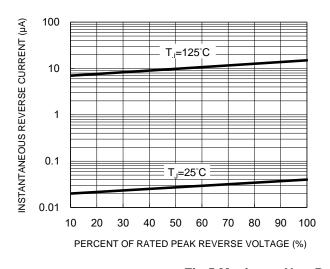


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



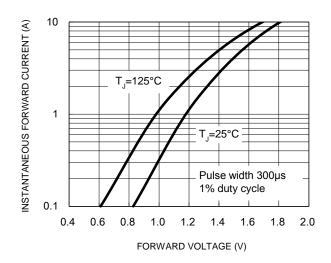
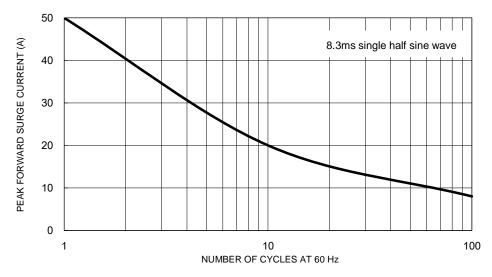


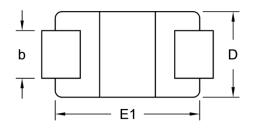
Fig.5 Maximum Non-Repetitive Forward Surge Current

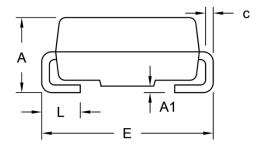




PACKAGE OUTLINE DIMENSIONS

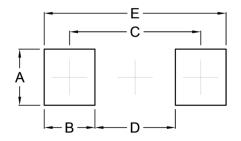
DO-214AC (SMA)





DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min.	Max.	Min.	Max.	
Α	1.99	2.50	0.078	0.098	
A1	0.10	0.20	0.004	0.008	
b	1.27	1.58	0.050	0.062	
С	0.15	0.31	0.006	0.012	
D	2.29	2.83	0.090	0.111	
E	4.95	5.33	0.195	0.210	
E1	4.06	4.60	0.160	0.181	
L	0.90	1.41	0.035	0.056	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

MARKING DIAGRAM



P/N = Marking Code G = Green Compound

YW = Date Code F = Factory Code



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